## imall

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## Contact us

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### DATASHEET

# 4 PIN SOP RANDOM-PHASE TRIAC PHOTOCOUPLER ELM302X, ELM305X Series



#### Features:

- Peak breakdown voltage
- 400V: ELM302X
- 600V: ELM305X
- High isolation voltage between input and output (Viso=3750 V rms)
- Compact dual-in-line package
- Pb free and RoHS compliant.
- UL approved (No. E214129)
- VDE approved (No.132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved

#### Description

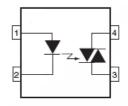
The ELM302X series and ELM305X series are optically isolated triac driver devices. These devices contain a GaAs infrared emitting diode and a light activated silicon bilateral switch, which functions like a triac.

They are designed for interfacing between electronic controls and power triacs to control resistive and inductive loads for 115 to 240 VAC operations.

#### **Applications**

- Solenoid/valve controls
- Lamp ballasts
- Static AC power switch
- Interfacing microprocessors to 115 to 240Vac peripherals
- Incandescent lamp dimmers
- Temperature controls
- Motor controls

#### **Schematic**



#### Pin Configuration

- 1. Anode
- 2. Cathode
- 3. Terminal 4. Terminal
- 4. reminal

#### Absolute Maximum Ratings (Ta=25℃)

	Parameter		Symbol	Rating	Unit	
Input	Forward current		I <sub>F</sub>	60	mA	
	Reverse voltage		V <sub>R</sub>	6	V	
	Power Dissipation		P <sub>D</sub>	100	mW	
Output	Off-state Output Terminal Voltage	ELM302X		400		
		ELM305X	– V <sub>DRM</sub>	600	– V	
	On state RMS current		I <sub>T(RMS)</sub>	70	mA(RMS)	
	Peak Repetitive Surge	Current	I <sub>TSM</sub>	1	А	
	Power dissipation		P <sub>C</sub>	300	mW	
Total power dissipation			P <sub>TOT</sub>	200	mW	
Isolation voltage <sup>*1</sup>			V <sub>ISO</sub>	3750	Vrms	
Operating temperature			T <sub>OPR</sub>	-40~+110	°C	
Storage temperature			T <sub>STG</sub>	-55~+150	°C	
Soldering Temperature*2			T <sub>SOL</sub>	260	°C	

#### Notes:

\*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

\*2 For 10 seconds

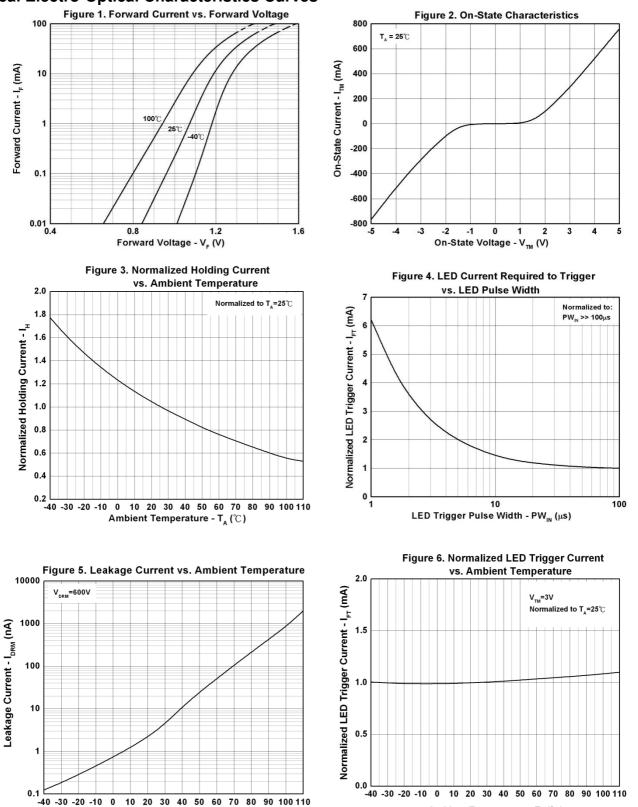
#### Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input							
Param	eter	Symbol	Min.	Тур.*	Max.	Unit	Condition
Forward Voltage	1	V <sub>F</sub>	-	1.2	1.5	V	I <sub>F</sub> = 10mA
Reverse Leakag	ge current	I <sub>R</sub>	-	-	10	μA	V <sub>R</sub> = 6V
Output							
Param	eter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Peak Blocking Current		I <sub>DRM</sub>	-	-	100	nA	$V_{DRM} = Rated V_{DRM}$ $I_F = 0mA$
Peak On-state Voltage		V <sub>TM</sub>	-	-	2.5	V	I <sub>TM</sub> =100mA peak, I <sub>F</sub> =Rated I <sub>FT</sub>
Critical Rate of Rise off-state	ELM302X	– dv/dt	-	10	-	V/µs	IF=0mA, Figure 8
Voltage	ELM305X	awat	1000	-	-		
Transfer Char	acteristics						
Param	eter	Symbol	Min.	Тур.*	Max.	Unit	Condition
	3022 3052		-	-	10		
LED Trigger Current	3023 3053	 I <sub>FT</sub>	-	-	5	mA	Main terminal Voltage=3V
	3024 3054		-	-	3		
Holding Current		Ι <sub>Η</sub>	-	3	5	mA	
Turn-on time		Ton	-	-	100	μS	VD=6V, RL=100ohm, IF=20mA

\* Typical values at  $T_a = 25 \,^{\circ}\text{C}$ 

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Ambient Temperature - T (°C)

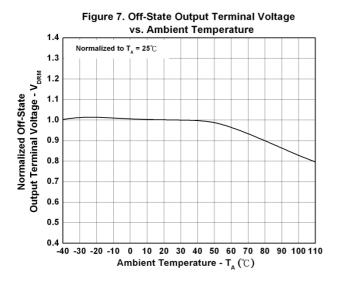
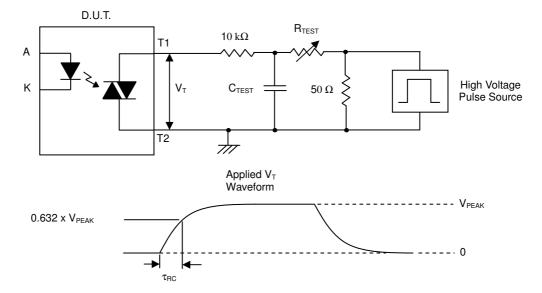


Figure 8. Static dv/dt Test Circuit & Waveform



#### **Measurement Method**

The high voltage pulse is set to the required V<sub>PEAK</sub> value and applied to the D.U.T. output side through the RC circuit above. LED current is not applied. The waveform V<sub>T</sub> is monitored using a x100 scope probe. By varying R<sub>TEST</sub>, the dv/dt (slope) is increased, until the D.U.T. is observed to trigger (waveform collapses). The dv/dt is then decreased until the D.U.T. stops triggering. At this point,  $\tau_{RC}$  is recorded and the dv/dt calculated.

$$dv/dt = -\frac{0.632 \times V_{\text{PEAK}}}{\tau_{\text{RC}}}$$

For example,  $V_{PEAK} = 400V$  for EL302X series. The dv/dt value is calculated as follows:

$$dv/dt = \frac{0.63 \times 400}{\tau_{RC}} = \frac{252}{\tau_{RC}}$$

#### **Order Information**

#### **Part Number**

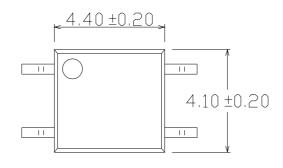


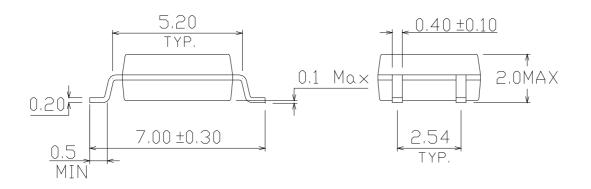
#### Note

- X = Part No. (2,3 or 4)
- Z = Tape and reel option (TA, TB or none).
- V = VDE safety approved (optional)

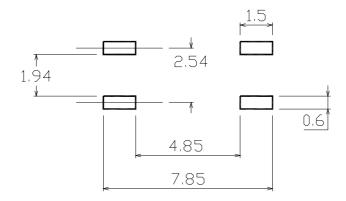
Option	Description	Packing quantity
None	Standard	100 units per tube
None	Standard + VDE safety optional	100 units per tube
(TA)	TA tape & reel option	3000 units per reel
(TB)	TB tape & reel option	3000 units per reel
(TA)-V	TA tape & reel option + VDE safety optional	3000 units per reel
(TB)-V	TB tape & reel option + VDE safety optional	3000 units per reel

#### Package Dimension (Dimensions in mm)





#### Recommended pad layout for surface mount leadform



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#### **Device Marking**

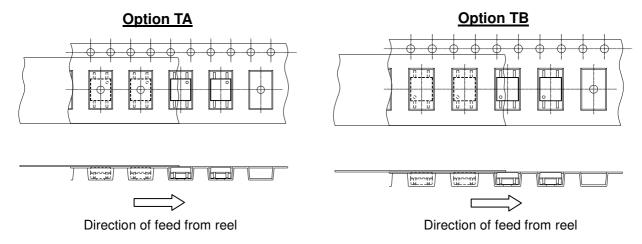


#### Notes

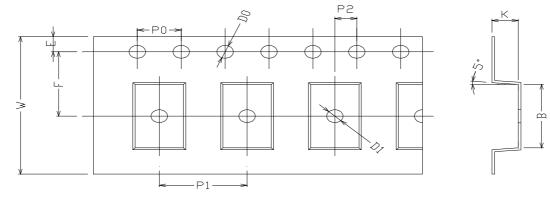
EL	denotes Everlight
M3054	denotes Device Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE safety option (optional)

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#### **Tape & Reel Packing Specifications**



#### **Tape dimensions**



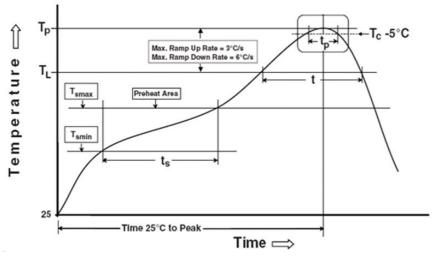


Dimension No.	Α	В	Do	D1	Е	F
Dimension (mm)	4.4 ± 0.1	7.4 ± 0.1	1.5 + 0.1/-0	1.5 ± 0.1	1.7 5± 0.1	7.5 ± 0.1

Dimension No.	Ро	P1	P2	t	W	К
Dimension (mm)	4.0 ± 0.15	8.0 ± 0.1	2.0 ± 0.1	0.25 ± 0.03	16.0 ± 0.2	2.4 ± 0.1

#### **Precautions for Use**

- 1. Soldering Condition
  - 1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

#### Preheat

Temperature min (T <sub>smin</sub> ) Temperature max (T <sub>smax</sub> )	150 ℃ 200 <i>°</i> C
Time ( $T_{smin}$ to $T_{smax}$ ) ( $t_s$ ) Average ramp-up rate ( $T_{smax}$ to $T_p$ )	60-120 seconds 3 ℃/second max
Other	
Liquidus Temperature (T <sub>L</sub> )	217 ℃
Time above Liquidus Temperature (t $_{L}$ )	60-100 sec
Peak Temperature (T <sub>P</sub> )	260 <i>°</i> C
Time within 5 $^{\circ}\!\mathrm{C}$ of Actual Peak Temperature: T_P - 5 $^{\circ}\!\mathrm{C}$	30 s
Ramp- Down Rate from Peak Temperature	6℃ /second max.
Time 25 ℃ to peak temperature Reflow times	8 minutes max. 3 times

Reference: IPC/JEDEC J-STD-020D

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